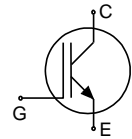
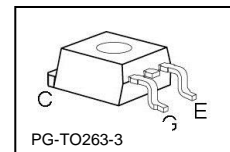


Low Loss IGBT : IGBT in TRENCHSTOP™ and Fieldstop technology



Features:

- Very low $V_{CE(sat)}$ 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5 μ s
- Designed for frequency inverters for washing machines, fans, pumps and vacuum cleaners
- TRENCHSTOP™ technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
- Positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Low Gate Charge
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC¹ for target applications
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



| Type | V_{CE} | I_C | $V_{CE(sat), T_j=25^\circ C}$ | $T_{j,max}$ | Marking Code | Package |
|-----------|----------|-------|-------------------------------|-------------|--------------|------------|
| IGB15N60T | 600V | 15A | 1.5V | 175°C | G15T60 | PG-TO263-3 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--------------------------------------------------------------------------------------|--------------|------------|---------|
| Collector-emitter voltage, $T_j \geq 25^\circ C$ | V_{CE} | 600 | V |
| DC collector current, limited by $T_{j,max}$ | I_C | 26 | A |
| $T_C = 25^\circ C$, value limited by bondwire | | 23 | |
| $T_C = 100^\circ C$ | | 23 | |
| Pulsed collector current, t_p limited by $T_{j,max}$ | $I_{C,puls}$ | 45 | |
| Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^\circ C$, $t_p = 1\mu s$ | - | 45 | |
| Gate-emitter voltage | V_{GE} | ± 20 | V |
| Short circuit withstand time ²⁾ | t_{SC} | 5 | μs |
| $V_{GE} = 15V$, $V_{CC} \leq 400V$, $T_j \leq 150^\circ C$ | | | |
| Power dissipation $T_C = 25^\circ C$ | P_{tot} | 130 | W |
| Operating junction temperature | T_j | -40...+175 | °C |
| Storage temperature | T_{stg} | -55...+150 | |
| Soldering temperature (reflow soldering, MSL1) | | 260 | |

¹ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|------------------------------------------|------------|---------------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, junction – case | R_{thJC} | | 1.15 | K/W |
| Thermal resistance, junction – ambient | R_{thJA} | 6cm ² Cu | 40 | |

Electrical Characteristic, at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--------------------------------------|---------------|-------------------------------------------------------------------------------|-------|------|------|---------------|
| | | | min. | Typ. | max. | |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{GE}=0V, I_C=0.2mA$ | 600 | - | - | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{GE} = 15V, I_C=15A$ $T_j=25^\circ\text{C}$ $T_j=175^\circ\text{C}$ | - | 1.5 | 2.05 | |
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $I_C=210\mu A, V_{CE}=V_{GE}$ | 4.1 | 4.9 | 5.7 | |
| Zero gate voltage collector current | I_{CES} | $V_{CE}=600V, V_{GE}=0V$ $T_j=25^\circ\text{C}$ $T_j=175^\circ\text{C}$ | - | - | 40 | μA |
| | | | - | - | 1000 | |
| Gate-emitter leakage current | I_{GES} | $V_{CE}=0V, V_{GE}=20V$ | - | - | 100 | nA |
| Transconductance | g_{fs} | $V_{CE}=20V, I_C=15A$ | - | 8.7 | - | S |
| Integrated gate resistor | R_{Gint} | | | - | | Ω |

Dynamic Characteristic

| | | | | | | |
|----------------------------------------------------------------|-------------|----------------------------------------------------------------------------------|---|-------|---|----|
| Input capacitance | C_{iss} | $V_{CE}=25V,$ $V_{GE}=0V,$ $f=1MHz$ | - | 860 | - | pF |
| Output capacitance | C_{oss} | | - | 55 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 24 | - | |
| Gate charge | Q_{Gate} | $V_{CC}=480V, I_C=15A$ $V_{GE}=15V$ | - | 87 | - | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L_E | | - | 7 | - | nH |
| Short circuit collector current ¹⁾ | $I_{C(SC)}$ | $V_{GE}=15V, t_{SC}\leq 5\mu s$ $V_{CC} = 400V,$ $T_j = 150^\circ\text{C}$ | - | 137.5 | - | A |

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

Switching Characteristic, Inductive Load, at $T_j=25\text{ °C}$

| Parameter | Symbol | Conditions | Value | | | Unit |
|----------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
| | | | min. | Typ. | max. | |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_j=25\text{ °C}$, $V_{CC}=400\text{V}$, $I_C=15\text{A}$, $V_{GE}=0/15\text{V}$, $r_G=15\Omega$, $L_\sigma=154\text{nH}$, $C_\sigma=39\text{pF}$ | - | 17 | - | ns |
| Rise time | t_r | | - | 11 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 188 | - | |
| Fall time | t_f | | - | 50 | - | |
| Turn-on energy | E_{on} | L_σ , C_σ from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW30N60T | - | 0.22 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.35 | - | |
| Total switching energy | E_{ts} | | - | 0.57 | - | |

Switching Characteristic, Inductive Load, at $T_j=175\text{ °C}$

| Parameter | Symbol | Conditions | Value | | | Unit |
|----------------------------|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
| | | | min. | Typ. | max. | |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_j=175\text{ °C}$, $V_{CC}=400\text{V}$, $I_C=15\text{A}$, $V_{GE}=0/15\text{V}$, $r_G=15\Omega$, $L_\sigma=154\text{nH}$, $C_\sigma=39\text{pF}$ | - | 17 | - | ns |
| Rise time | t_r | | - | 15 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 212 | - | |
| Fall time | t_f | | - | 79 | - | |
| Turn-on energy | E_{on} | L_σ , C_σ from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW30N60T | - | 0.34 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.47 | - | |
| Total switching energy | E_{ts} | | - | 0.81 | - | |

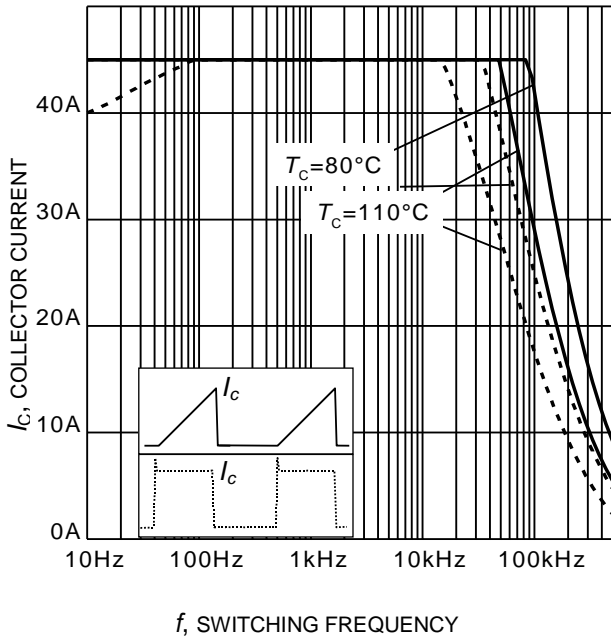


Figure 1. Collector current as a function of switching frequency
 ($T_j \leq 175^\circ\text{C}$, $D = 0.5$, $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $r_G = 15\Omega$)

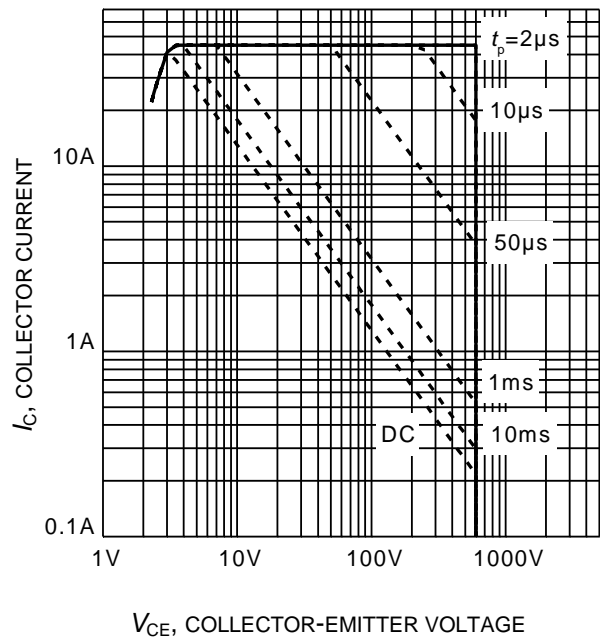


Figure 2. Safe operating area
 ($D = 0$, $T_C = 25^\circ\text{C}$, $T_j \leq 175^\circ\text{C}$; $V_{GE} = 0/15\text{V}$)

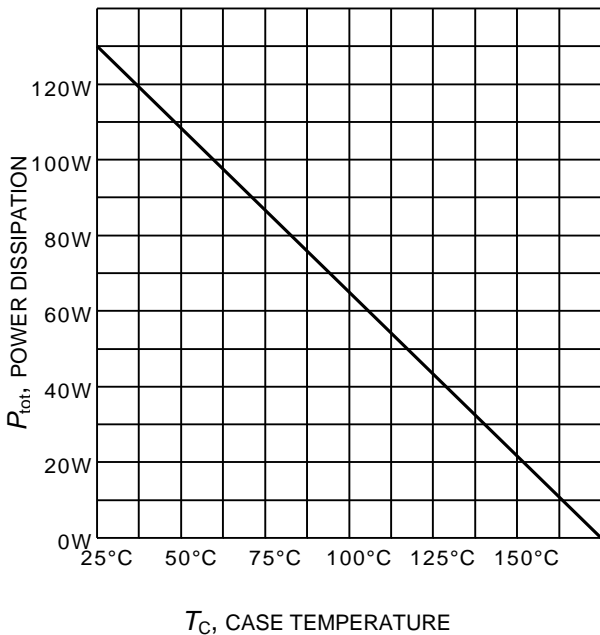


Figure 3. Power dissipation as a function of case temperature
 ($T_j \leq 175^\circ\text{C}$)

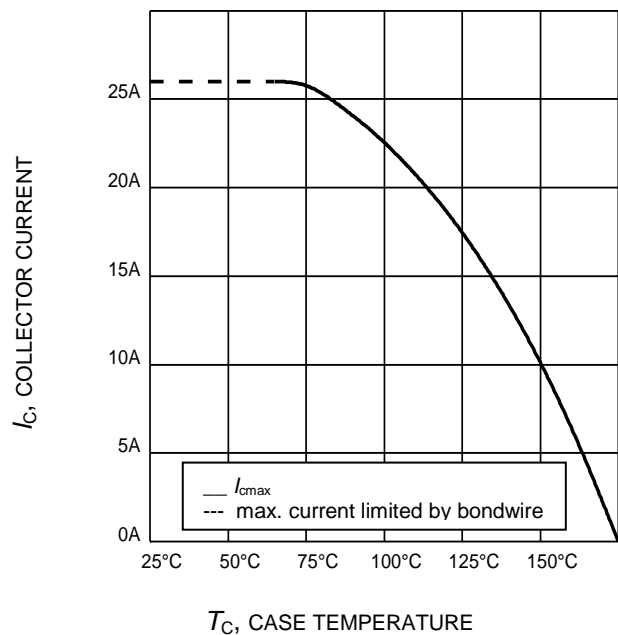


Figure 4. Collector current as a function of case temperature
 ($V_{GE} \geq 15\text{V}$, $T_j \leq 175^\circ\text{C}$)

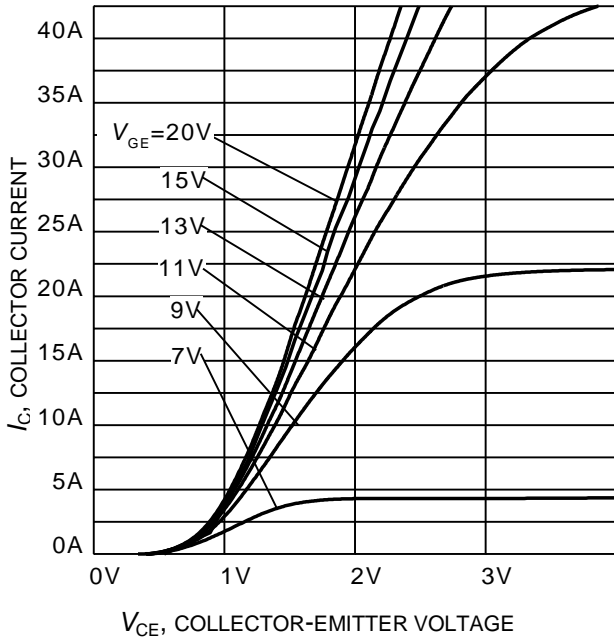


Figure 5. Typical output characteristic
($T_j = 25^\circ\text{C}$)

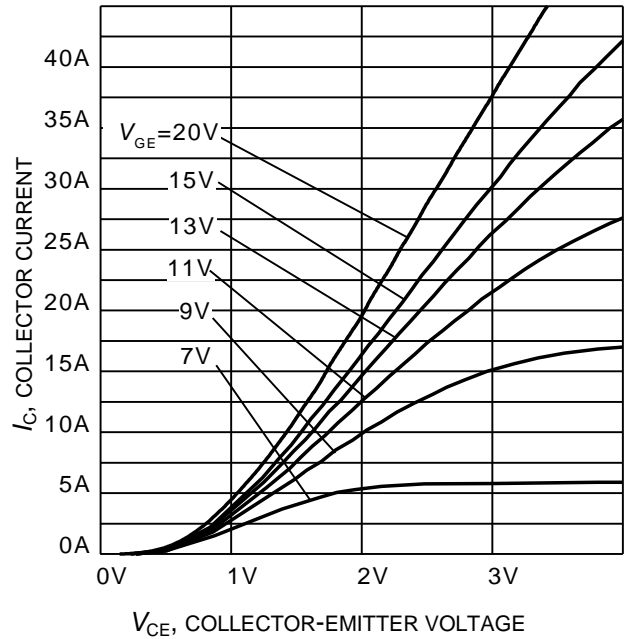


Figure 6. Typical output characteristic
($T_j = 175^\circ\text{C}$)

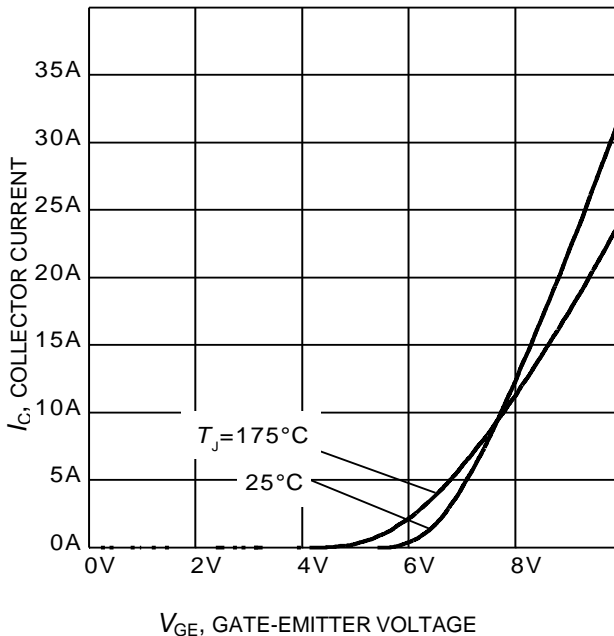


Figure 7. Typical transfer characteristic
($V_{CE} = 20\text{V}$)

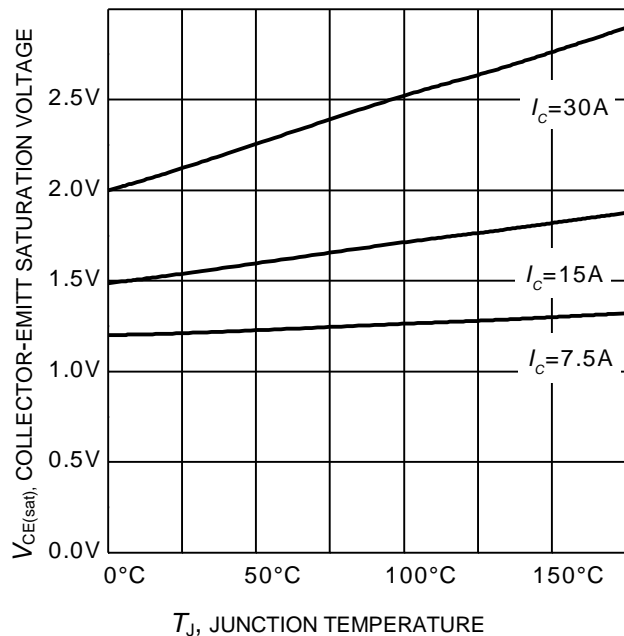
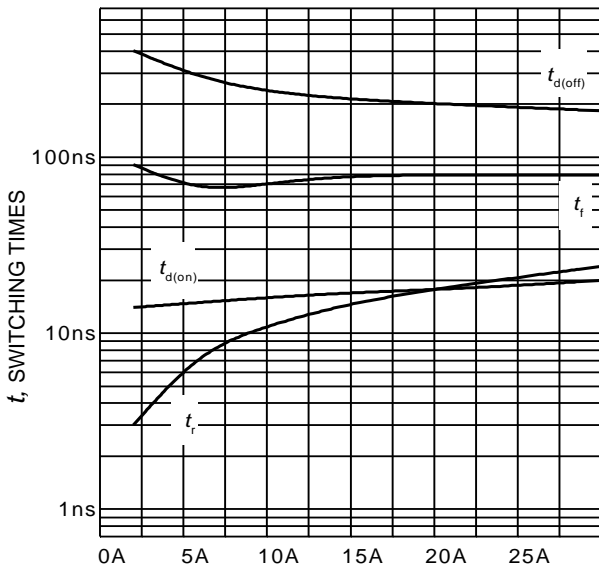
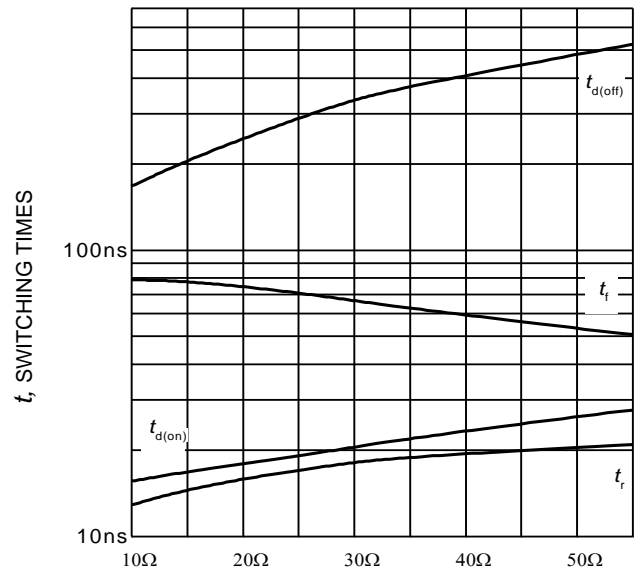


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
($V_{GE} = 15\text{V}$)



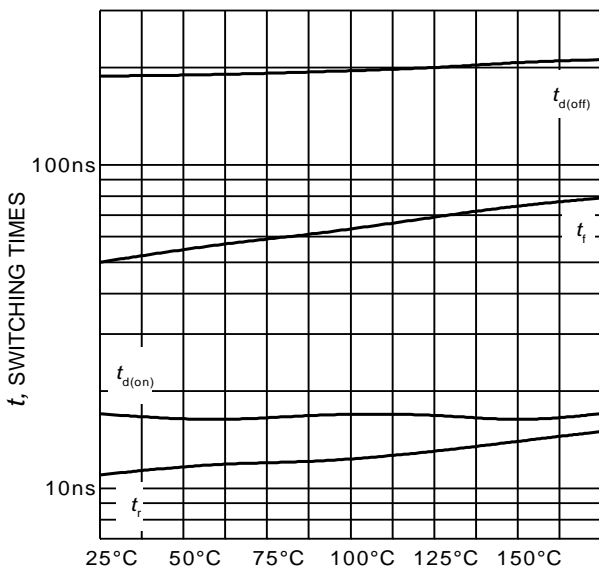
I_C , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current
(inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $r_G = 15\Omega$,
Dynamic test circuit in Figure E)



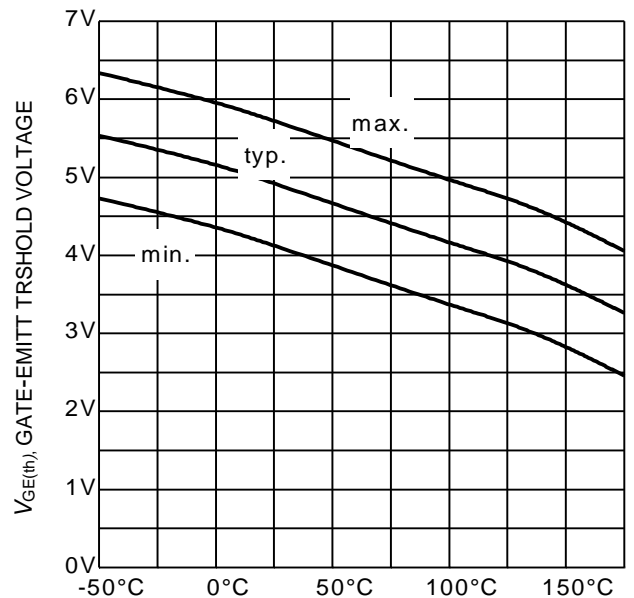
R_G , GATE RESISTOR

Figure 10. Typical switching times as a function of gate resistor
(inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 15\text{A}$,
Dynamic test circuit in Figure E)



T_J , JUNCTION TEMPERATURE

Figure 11. Typical switching times as a function of junction temperature
(inductive load, $V_{CE} = 400\text{V}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 15\text{A}$, $r_G=15\Omega$,
Dynamic test circuit in Figure E)



T_J , JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature
($I_C = 0.21\text{mA}$)

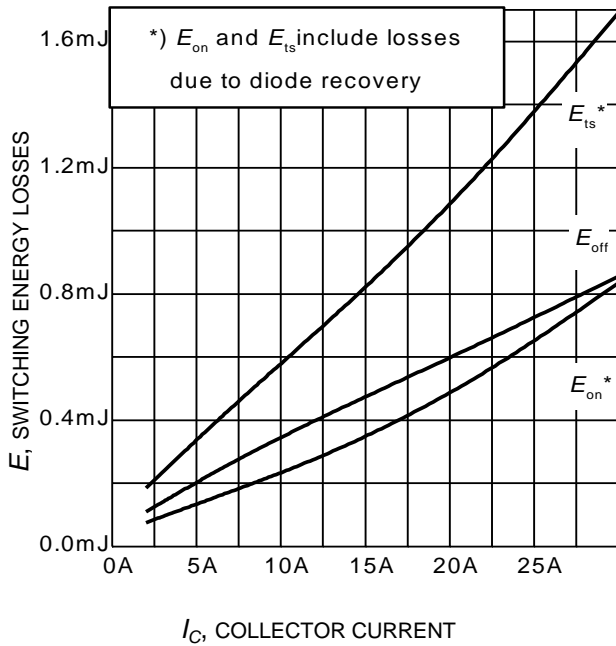


Figure 13. Typical switching energy losses as a function of collector current
(inductive load, $T_J = 175^\circ\text{C}$, $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $r_G = 15\Omega$, Dynamic test circuit in Figure E)

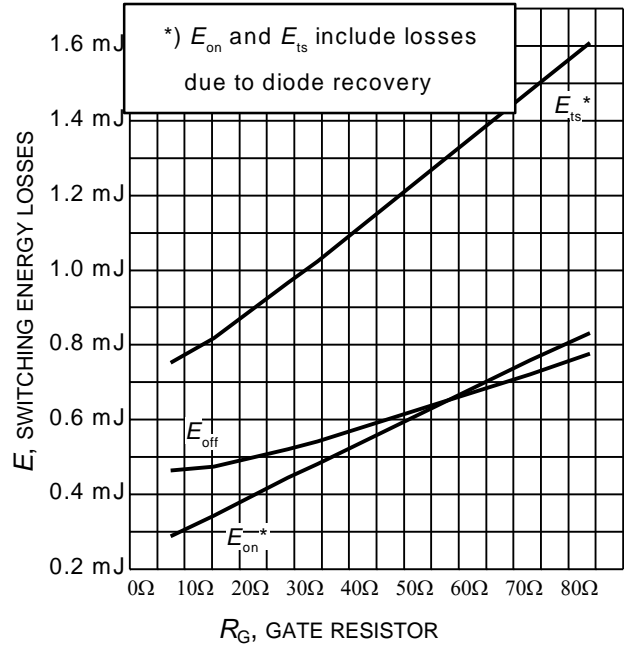


Figure 14. Typical switching energy losses as a function of gate resistor
(inductive load, $T_J = 175^\circ\text{C}$, $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 15\text{A}$, Dynamic test circuit in Figure E)

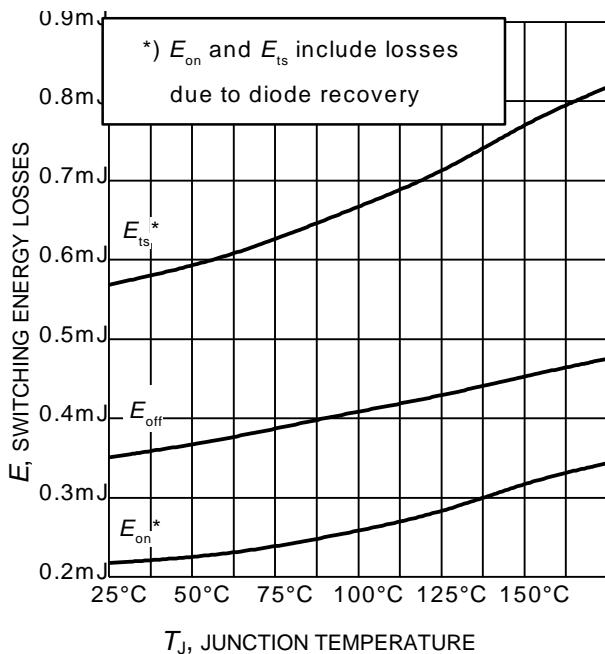


Figure 15. Typical switching energy losses as a function of junction temperature
(inductive load, $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 15\text{A}$, $r_G = 15\Omega$, Dynamic test circuit in Figure E)

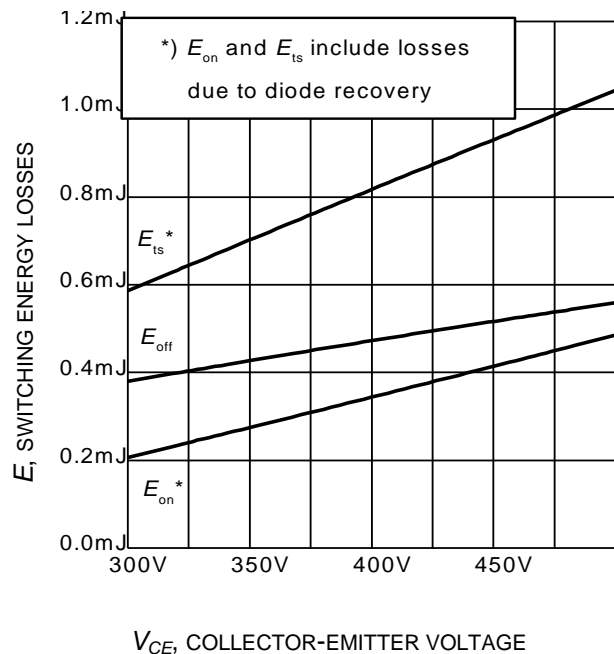


Figure 16. Typical switching energy losses as a function of collector emitter voltage
(inductive load, $T_J = 175^\circ\text{C}$, $V_{GE} = 0/15\text{V}$, $I_C = 15\text{A}$, $r_G = 15\Omega$, Dynamic test circuit in Figure E)

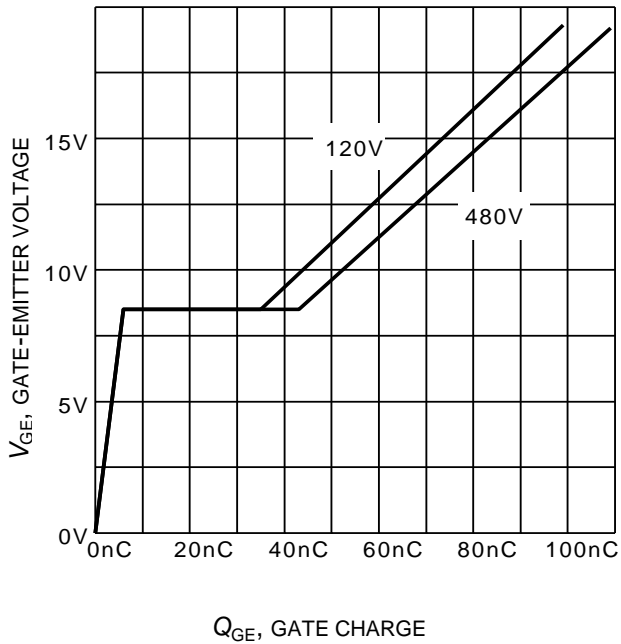


Figure 17. Typical gate charge
($I_C=15\text{ A}$)

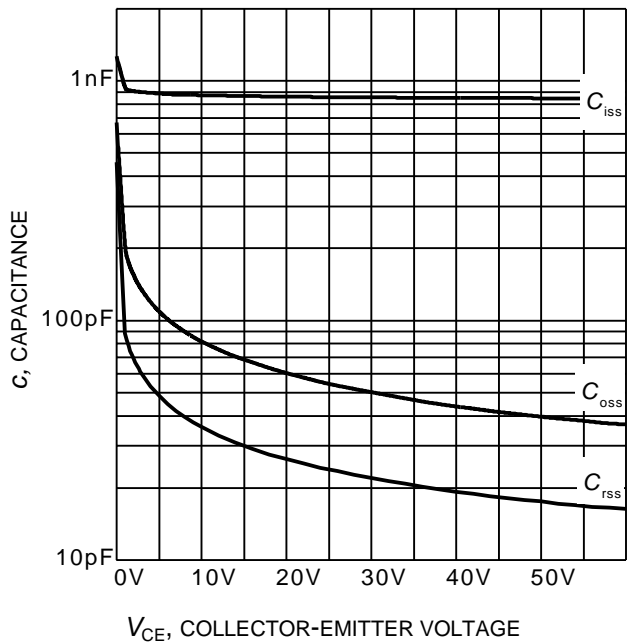


Figure 18. Typical capacitance as a function of collector-emitter voltage
($V_{GE}=0\text{V}$, $f = 1\text{ MHz}$)

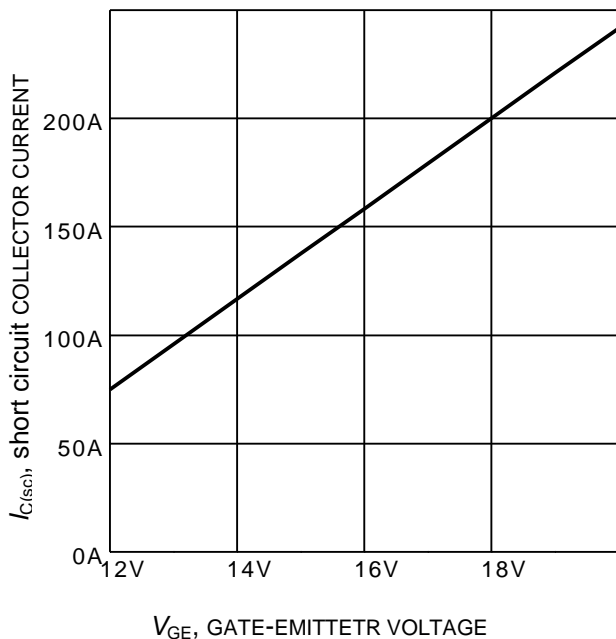


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage
($V_{CE} \leq 400\text{V}$, $T_J \leq 150^\circ\text{C}$)

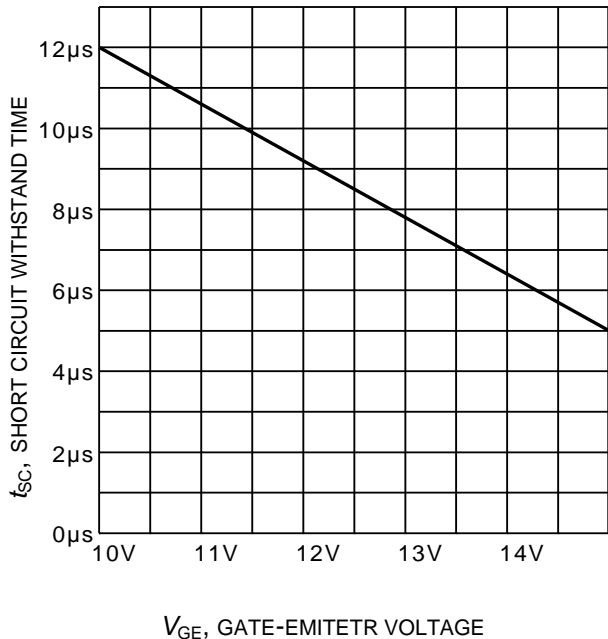


Figure 20. Short circuit withstand time as a function of gate-emitter voltage
($V_{CE}=400\text{V}$, start at $T_J=25^\circ\text{C}$, $T_{Jmax}<150^\circ\text{C}$)

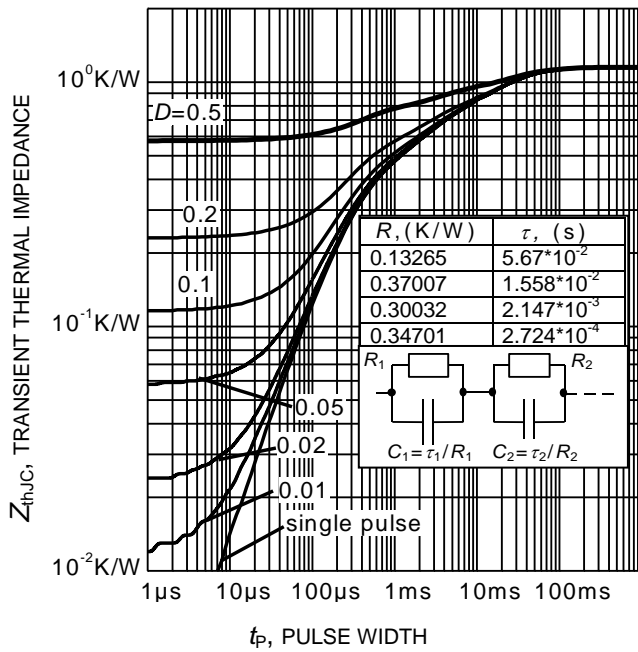
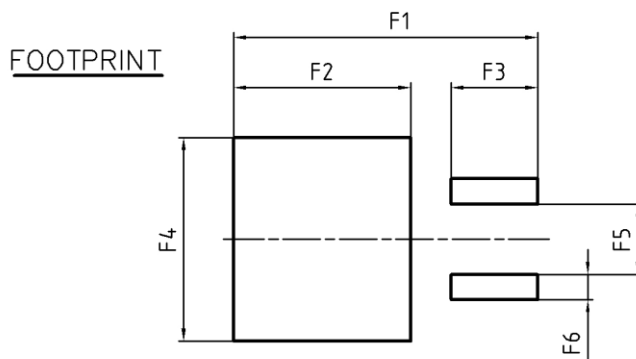
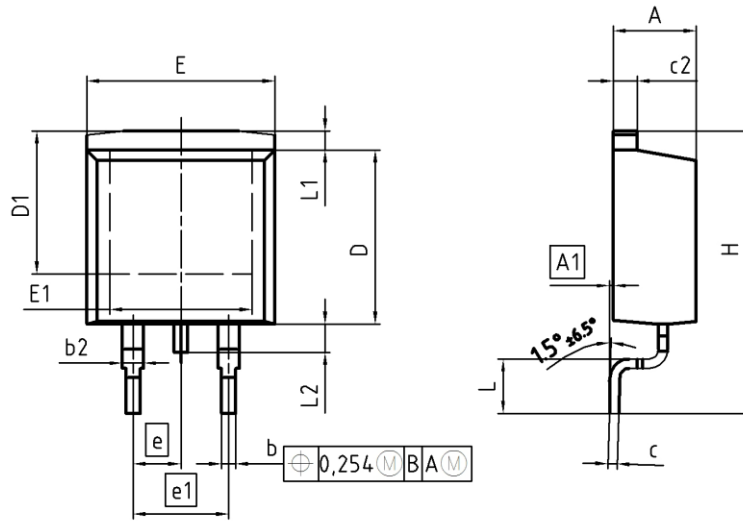


Figure 21. IGBT transient thermal impedance
 $(D = t_p / T)$

PG-TO263-3



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.30 | 4.57 | 0.169 | 0.180 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.65 | 0.85 | 0.026 | 0.033 |
| b2 | 0.95 | 1.15 | 0.037 | 0.045 |
| c | 0.33 | 0.65 | 0.013 | 0.026 |
| c2 | 1.17 | 1.40 | 0.046 | 0.055 |
| D | 8.51 | 9.45 | 0.335 | 0.372 |
| D1 | 7.10 | 7.90 | 0.280 | 0.311 |
| E | 9.80 | 10.31 | 0.386 | 0.406 |
| E1 | 6.50 | 8.60 | 0.256 | 0.339 |
| e | 2.54 | | 0.100 | |
| e1 | 5.08 | | 0.200 | |
| N | 2 | | 2 | |
| H | 14.61 | 15.88 | 0.575 | 0.625 |
| L | 2.29 | 3.00 | 0.090 | 0.118 |
| L1 | 0.70 | 1.60 | 0.028 | 0.063 |
| L2 | 1.00 | 1.78 | 0.039 | 0.070 |
| F1 | 16.05 | 16.25 | 0.632 | 0.640 |
| F2 | 9.30 | 9.50 | 0.366 | 0.374 |
| F3 | 4.50 | 4.70 | 0.177 | 0.185 |
| F4 | 10.70 | 10.90 | 0.421 | 0.429 |
| F5 | 3.65 | 3.85 | 0.144 | 0.152 |
| F6 | 1.25 | 1.45 | 0.049 | 0.057 |

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| EUROPEAN PROJECTION |
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| REVISION 01 |

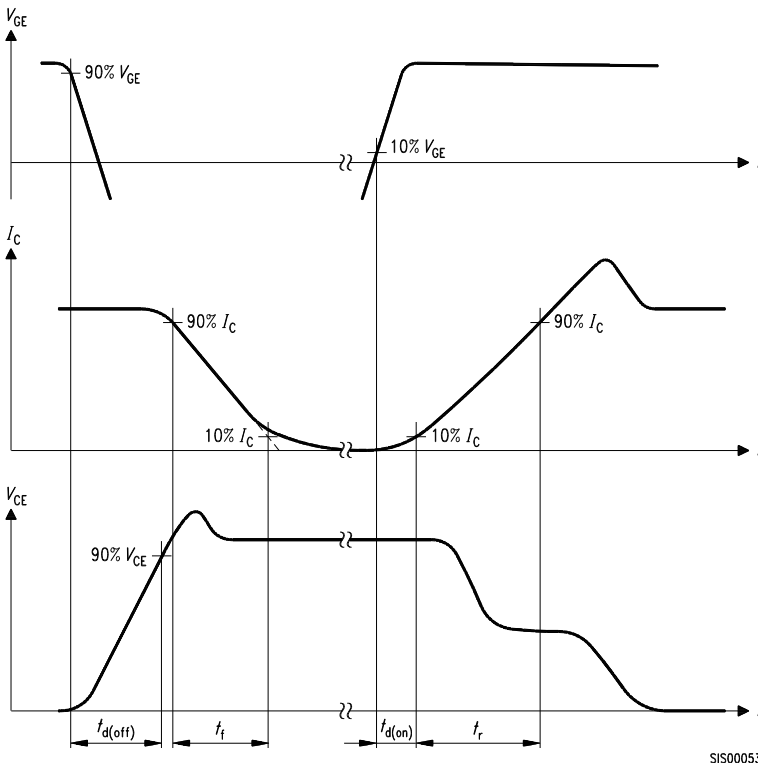


Figure A. Definition of switching times

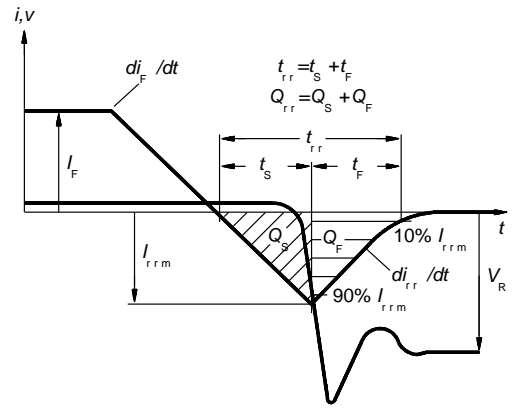


Figure C. Definition of diodes switching characteristics

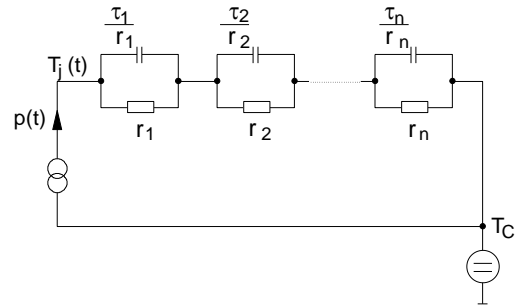


Figure D. Thermal equivalent circuit

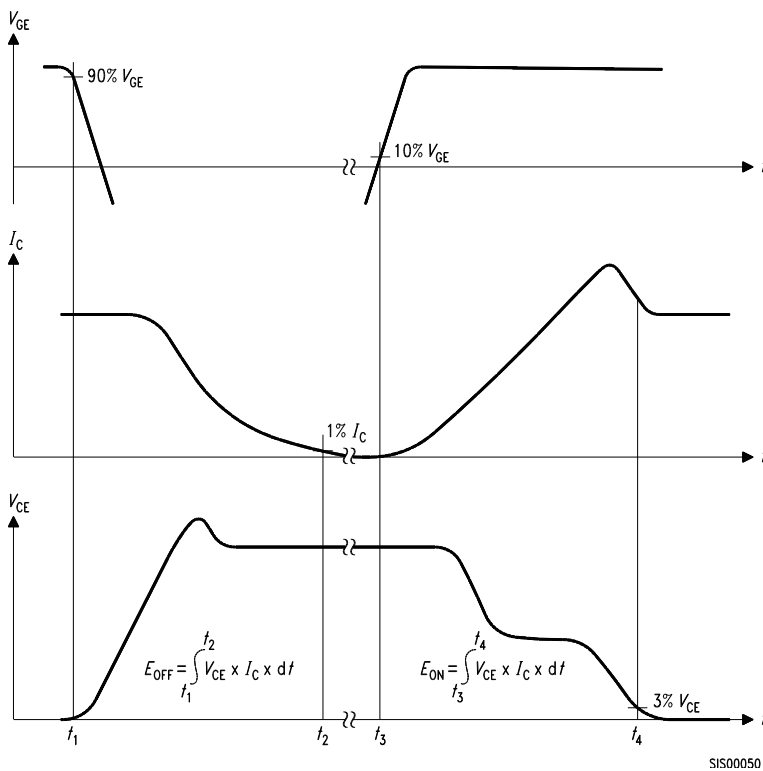


Figure B. Definition of switching losses

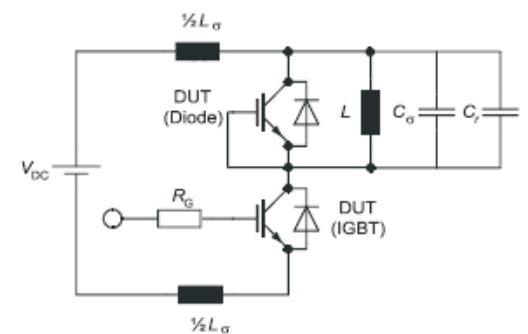


Figure E. Dynamic test circuit
Parasitic inductance L_σ ,
Parasitic capacitor C_σ ,
Relief capacitor C_r
(only for ZVT switching)

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
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- Наличие сертификата ISO.

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Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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